

# 50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor Rev. 01 — 5 April 2007 Pro

Product data sheet

#### **Product profile** 1.

#### 1.1 General description

NPN/PNP double low V<sub>CEsat</sub> Breakthrough In Small Signal (BISS) transistor in a medium power Surface-Mounted Device (SMD) plastic package.

#### Table 1. Product overview

Type number	Package N		NPN/NPN	PNP/PNP	
	Nexperia	Name	complement	complement	
PBSS4350SPN	SOT96-1	SO8	PBSS4350SS	PBSS5350SS	

#### 1.2 Features

- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain (h<sub>FF</sub>) at high I<sub>C</sub>
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

#### 1.3 Applications

- Complementary MOSFET driver
- Half and full bridge motor drivers
- Dual low power switches (e.g. motors, fans)
- Automotive

#### 1.4 Quick reference data

Table 2.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1; NP	N low V <sub>CEsat</sub> transistor					
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	50	V
I <sub>C</sub>	collector current		-	-	2.7	А
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	-	5	А
R <sub>CEsat</sub>	collector-emitter saturation resistance	I <sub>C</sub> = 2 A; I <sub>B</sub> = 200 mA	<u>[1]</u> _	90	130	mΩ

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#### 50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor

Table 2.	Quick reference data	.continued				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR2; PN	P low V <sub>CEsat</sub> transistor					
$V_{\text{CEO}}$	collector-emitter voltage	open base	-	-	-50	V
I <sub>C</sub>	collector current		-	-	-2.7	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms	-	-	-5	A
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{\rm C} = -2 \text{ A};$ $I_{\rm B} = -200 \text{ mA}$	<u>[1]</u> -	95	140	mΩ

[1] Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta \le 0.02$ .

### 2. Pinning information

Table 3.	Pinning					
Pin	Description	Simplified outline	Symbol			
1	emitter TR1					
2	base TR1					
3	emitter TR2					
4	base TR2					
5	collector TR2		1 2 3 4			
6	collector TR2		<i>006aaa985</i>			
7	collector TR1					
8	collector TR1					

### 3. Ordering information

Table 4.         Ordering information						
Type number	Package					
	Name	Description	Version			
PBSS4350SPN	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1			

### 4. Marking

Table 5. Ma	irking codes	
Type number		Marking code
PBSS4350SP	N	4350SPN

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### 5. Limiting values

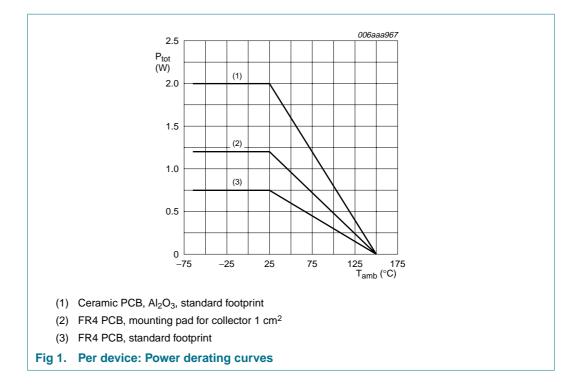
Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor; for the PNP transistor	with negative polarity	/		
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>C</sub>	collector current		-	2.7	А
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 ms$	-	5	А
I <sub>B</sub>	base current		-	0.5	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	0.55	W
			[2] _	0.87	W
			<u>[3]</u>	1.43	W
Per device	)				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	0.75	W
			[2] _	1.2	W
			<u>[3]</u> _	2	W
Тj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on a ceramic PCB,  $AI_2O_3$ , standard footprint.

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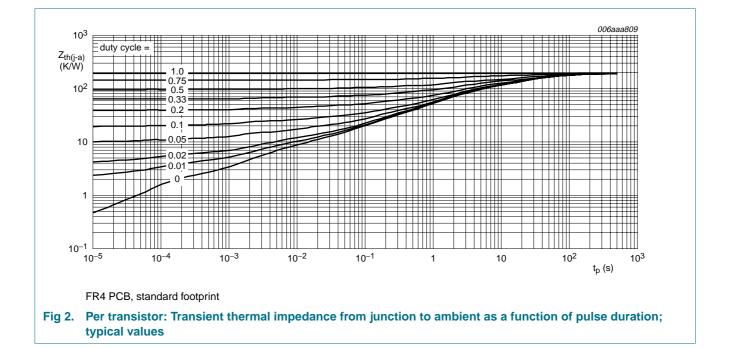
### 6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
·········	thermal resistance from	in free air	<u>[1]</u>	-	227	K/W
	junction to ambient		[2] _	-	144	K/W
			[3]	-	87	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	40	K/W
Per devic	e					
R <sub>th(j-a)</sub>	thermal resistance from	in free air	<u>[1]</u> _	-	167	K/W
	junction to ambient		[2] _	-	104	K/W
			[3] _	-	63	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

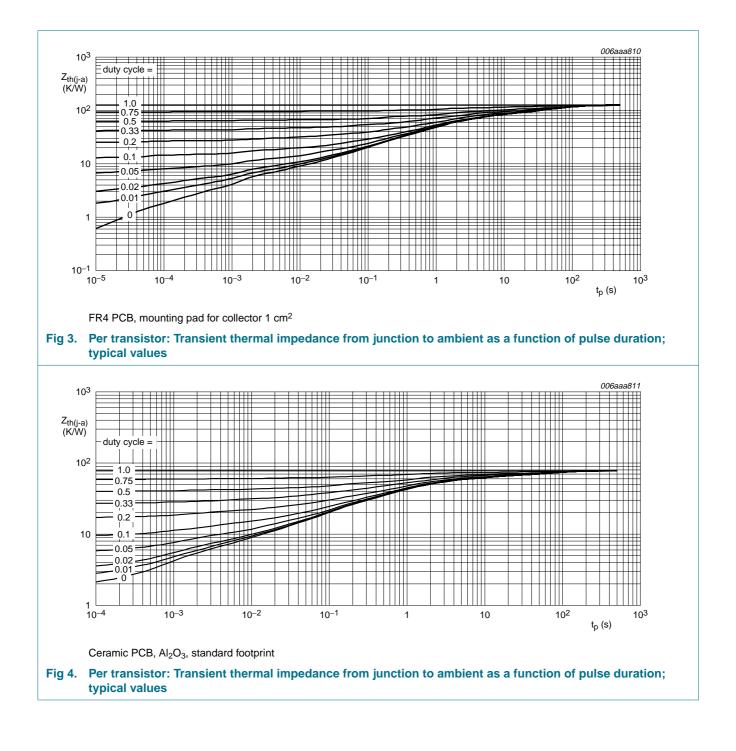
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on a ceramic PCB,  $AI_2O_3$ , standard footprint.



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#### 50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor



50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor

### 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1; NP	N low V <sub>CEsat</sub> transisto	r					
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = 50 \text{ V}; \text{ I}_{E} = 0 \text{ A}$		-	-	100	nA
	current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$		-	-	50	μA
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = 50 \text{ V};  V_{BE} = 0 \text{ V}$		-	-	100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$		-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 2 \text{ V}; I_{C} = 100 \text{ mA}$		300	520	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 500 \text{ mA}$	<u>[1]</u>	300	500	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 1 \text{ A}$	<u>[1]</u>	300	470	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 2 \text{ A}$	<u>[1]</u>	200	340	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 2.7 \text{ A}$	<u>[1]</u>	120	180	-	
V <sub>CEsat</sub>	collector-emitter		<u>[1]</u>				
	saturation voltage	$I_{\rm C}$ = 0.5 A; $I_{\rm B}$ = 50 mA		-	50	80	mV
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 50 mA		-	100	160	mV
		I <sub>C</sub> = 2 A; I <sub>B</sub> = 100 mA		-	190	280	mV
		$I_{C} = 2 \text{ A}; I_{B} = 200 \text{ mA}$		-	180	260	mV
		$I_{C} = 2.7 \text{ A}; I_{B} = 270 \text{ mA}$		-	240	340	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C} = 2 \text{ A}; I_{B} = 200 \text{ mA}$	[1]	-	90	130	mΩ
V <sub>BEsat</sub>	base-emitter		[1]				
	saturation voltage	I <sub>C</sub> = 2 A; I <sub>B</sub> = 100 mA		-	0.95	1.1	V
		$I_{C} = 2.7 \text{ A}; I_{B} = 270 \text{ mA}$		-	1.1	1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = 2 V; I_C = 1 A$	<u>[1]</u>	-	0.8	1.2	V
t <sub>d</sub>	delay time	$V_{CC} = 10 \text{ V}; I_{C} = 2 \text{ A};$		-	8	-	ns
t <sub>r</sub>	rise time	$I_{Bon} = 100 \text{ mA};$		-	96	-	ns
t <sub>on</sub>	turn-on time	– I <sub>Boff</sub> = –100 mA		-	104	-	ns
t <sub>s</sub>	storage time			-	355	-	ns
t <sub>f</sub>	fall time			-	165	-	ns
t <sub>off</sub>	turn-off time			-	520	-	ns
C <sub>c</sub>	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A}; \\ f = 1 \text{ MHz} \end{array}$		-	18	25	pF

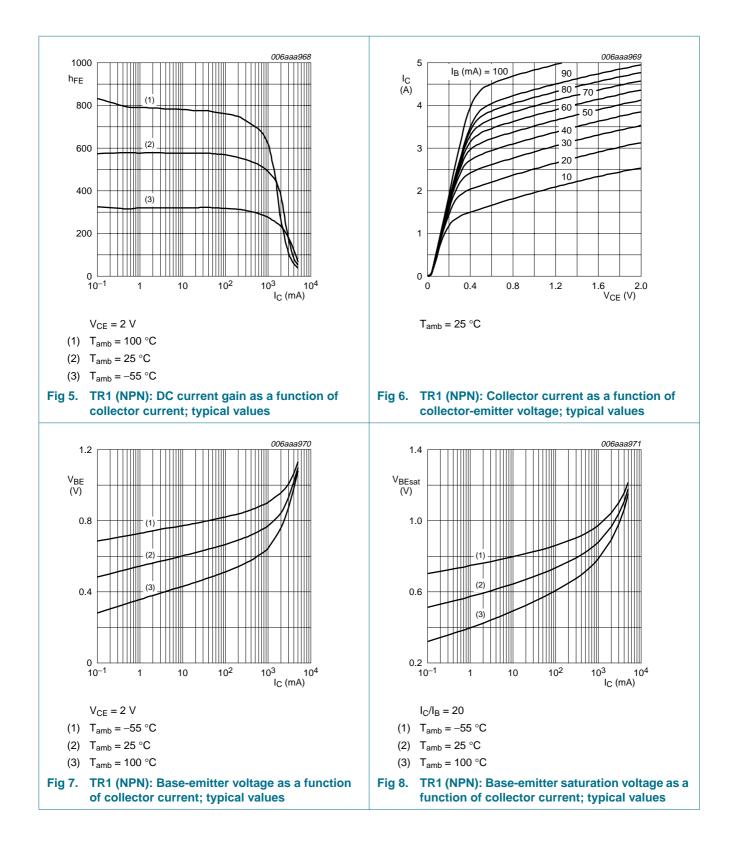
#### 50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor

Symbol	Parameter	Conditions		Min	Тур	Мах	Uni
TR2; PN	P low V <sub>CEsat</sub> transisto	r					
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}$		-	-	-100	nA
	current	$\label{eq:V_CB} \begin{split} V_{CB} &= -50 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \\ T_{j} &= 150 ^{\circ}\text{C} \end{split}$		-	-	-50	μA
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = -50 \text{ V};  V_{BE} = 0 \text{ V}$		-	-	-100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 V; I_C = 0 A$		-	-	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -100 \text{ mA}$		200	340	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -500 \text{ mA}$	[1]	200	290	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	[1]	180	250	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2 \text{ A}$	[1]	130	180	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2.7 \text{ A}$	[1]	95	135	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage		[1]				
		$I_{C} = -0.5 \text{ A}; I_{B} = -50 \text{ mA}$		-	-60	-90	mV
		$I_{C} = -1 \text{ A}; I_{B} = -50 \text{ mA}$		-	-125	-180	mV
		$I_{C} = -2 \text{ A}; I_{B} = -100 \text{ mA}$		-	-225	-320	mV
		$I_{C} = -2 \text{ A}; I_{B} = -200 \text{ mA}$		-	-190	-280	mV
		$I_{C} = -2.7 \text{ A}; I_{B} = -270 \text{ mA}$		-	-255	-370	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C} = -2 \text{ A}; I_{B} = -200 \text{ mA}$	<u>[1]</u>	-	95	140	mΩ
V <sub>BEsat</sub>	base-emitter		[1]				
	saturation voltage	$I_{C} = -2 \text{ A}; I_{B} = -100 \text{ mA}$		-	-0.95	-1.1	V
		$I_{C} = -2.7 \text{ A}; I_{B} = -270 \text{ mA}$		-	-1	-1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = -2 V; I_C = -1 A$	<u>[1]</u>	-	-0.8	-1.2	V
t <sub>d</sub>	delay time	$V_{CC} = -10 \text{ V}; I_C = -2 \text{ A};$		-	9	-	ns
t <sub>r</sub>	rise time	$I_{Bon} = -100 \text{ mA};$		-	54	-	ns
t <sub>on</sub>	turn-on time	I <sub>Boff</sub> = 100 mA		-	63	-	ns
t <sub>s</sub>	storage time			-	190	-	ns
t <sub>f</sub>	fall time			-	50	-	ns
t <sub>off</sub>	turn-off time			-	240	-	ns
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz		-	25	35	pF

#### Table 8. Characteristics ...continued

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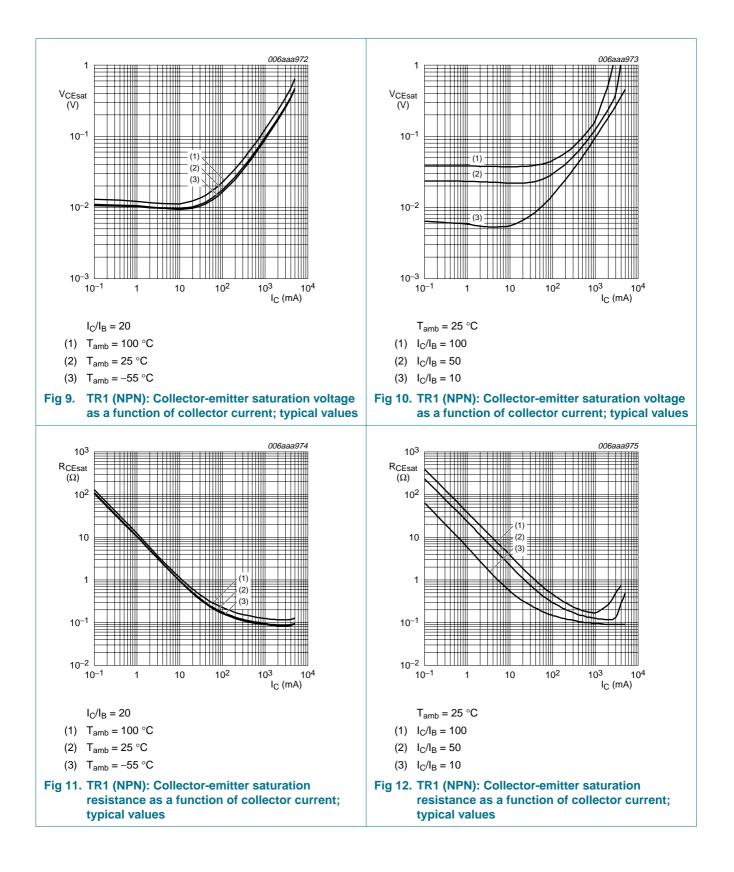
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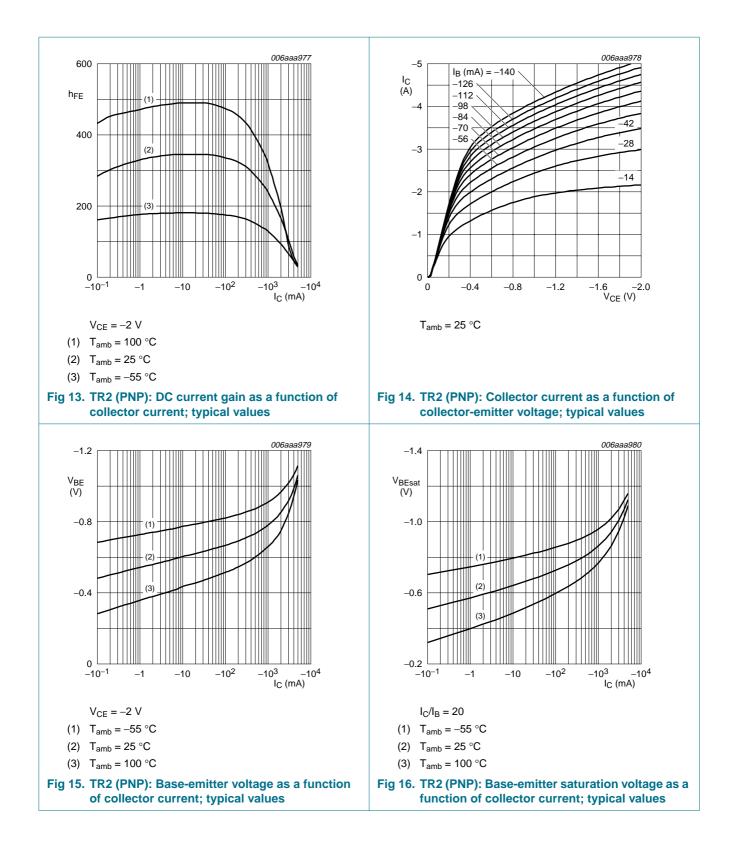
50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor



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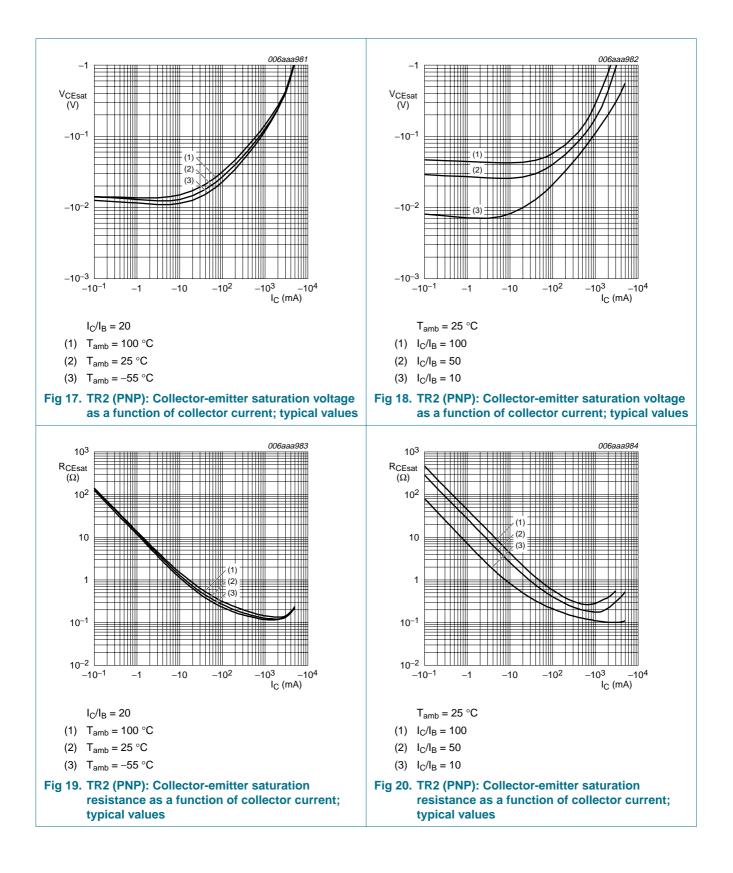
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# PBSS4350SPN

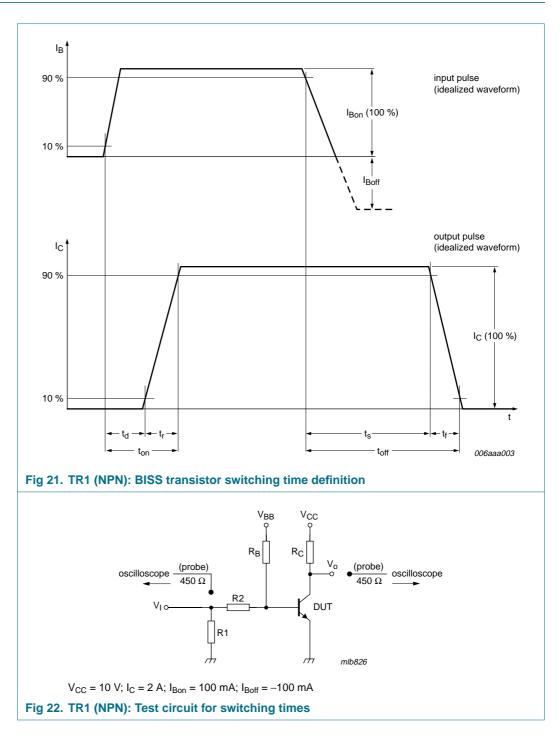
50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor



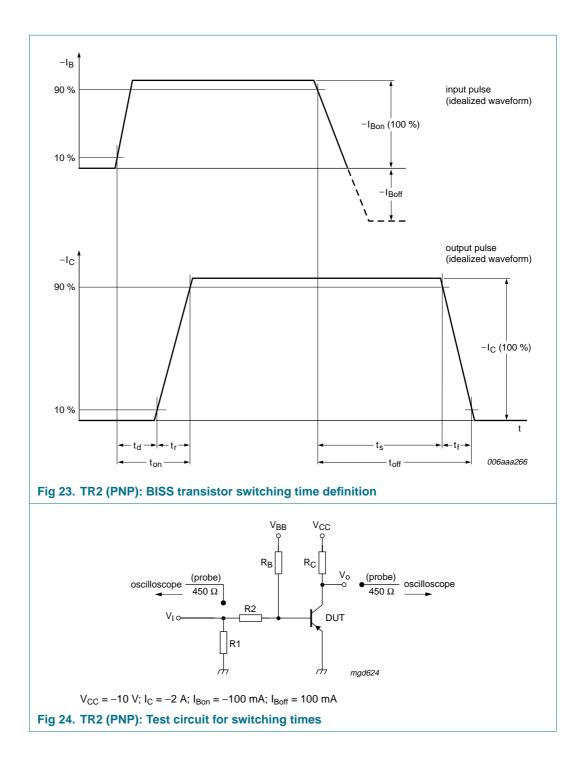
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### 8. Test information

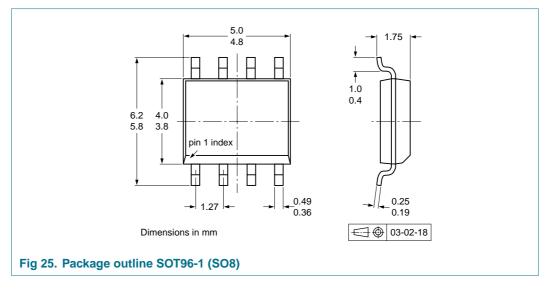


#### 50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor



50 V, 2.7 A NPN/PNP low V<sub>CEsat</sub> (BISS) transistor

### 9. Package outline



### **10. Packing information**

#### Table 9. Packing methods

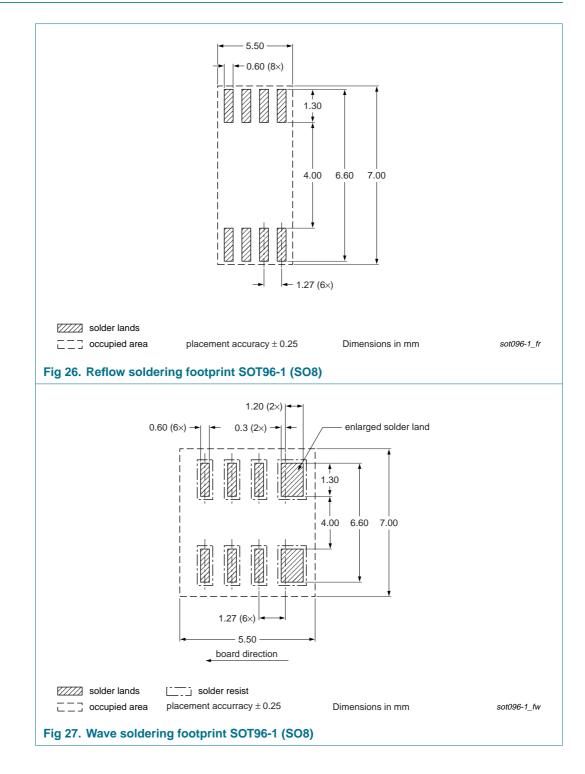
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			1000	2500
PBSS4350SPN	SOT96-1	8 mm pitch, 12 mm tape and reel	-115	-118

[1] For further information and the availability of packing methods, see Section 14.

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### **11. Soldering**



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### **12. Revision history**

Table 10. Revision history								
Document ID	Release date	Data sheet status	Change notice	Supersedes				
PBSS4350SPN_1	20070405	Product data sheet	-	-				

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### **13. Legal information**

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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